MosaicCORE[®] C209SP



TECHNICAL SUMMARY

200 x 150 RESOLUTION

Specifications	Descr	iption			
Microbolometer	Uncooled Var				
Pixel Pitch		12 Microns			
Spectral Response	7.8 - 14				
Sensor Resolution (Array Format)		200 (h) x 150 (v); 30,000 pixels			
Frame Rate		200 (ii) x 130 (V), 30,000 pixels <9 Hz			
Imaging Range ¹		-40°C to 330°C			
Sensor Sensitivity		-40 C to 330 C 65 mK (typical), <100 mK (max) @ 25°C			
Non-Uniformity Correction (NUC)	Automatic NUC (with shutter)				
Video Output Interfaces	USB				
Supply Voltage		3.3V to 5.0V			
Power: Core Only		<50mW			
Power: Core + Interface Board	3001	300mW			
Output Frame Formats					
Supported OS	Linux / Windows SDK	Android SDK			
Partially Processed	16-bit corrected or pre AGC	16-bit filtered pre AGC			
Colorized Display	ARGB888, RGB565, AYUV, or YUY2	32-bit ARGB post colorization in the Bitmap image			
B/W Display	8-bit Greyscale	NA			
Tempeature	32-bit floating point or 16-bit fixed point thermography	16-bit fixed point thermography			
Optics & Mechanical					
Focal Length	9.1	9.1mm			
F-number (focal length/aperture)	f/1	f/1.0			
Spatial Resolution (IFOV, center)	1.3				
HFOV ⁴	15°				
VFOV ⁴	12°				
Detection Range ²	758m				
Recognition Range ²	190	190m			
Identification Range ²	108	108m			
Distance to Spot Ratio	126:1				
Ingress Protection	IP67				
Core Dimensions (L x W x H)	20 x 20 x 21mm				
Core Weight	12	12 g			
Focus	Fix	ed			
Lens Material	Chalco	genide			
Thermography					
Temperature Calibration	Calibrated Out	put in °C, °F, K			
	The greater of ±5°C or 5% between	The greater of ±5°C or 5% between 5°C to 140°C scene temperatures			
Temperature Accuracy ^{1,3}	Typical performance of ±10% between 140°C to 330°C scene temperatures Contact				
	your sales rep for higher temperature accuracy up to 330°C and beyond				
Environmental					
	-10°C t	-10°C to 60°C			
Operating Temperature Range	Contact your sales rep for higher operating temperature ranges				
Storage Temperature Range	-40°C to 80°C				
Solar Protection	Yes				
Humidity	10%~95%RH, non-condensing				
	ROHS, WEEE, REACH				
Regulatory	ROHS, WE	NOIS, WELL, NEACH			

 Specified at nominal 25°C ambient operating temperature and nominal measurement distance of 12 inches. Temperature reported is Center Spot temperature, which is an average of the center 36 pixels. Contact Seek Thermal for performance at other nominal operating temperatures and measurement distances.

2. Based on Johnson Criteria.

3. Factory default emissivity is set to 0.97. Emissivity is adjustable using the SDK. See data sheet for more information.

Specifications and undocumented specifications are subject to change without notice. For the most up-to-date specifications, visit thermal.com/oem

D	THIS DRAWING COVERS THE FOLLOWING SKUS: C2*9* C3*9* S2*9* S3*9*	NO COPROCESSOR BOARD	"P" OPTION WITH CO
С			
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	NOTES: 1. SEE 3D CAD FILE FOR FULL GEOMETRY. 2. KEEPOUT FOR SHUTTER CLEARANCE.		
A	 2.3 REEPOUTFOR SHUTTER CLEARANCE. 3. LENS ADHESIVE DOES NOT EXTEND ABOV 2. THIS DESIGN IS CAPABLE OF BEING IP67 WHE APPROPRIATE SEALING DESIGN. SEE MOSAI 5. ADHESIVE BUMP PRESENT ON <9Hz CORE 	EN USED WITH C DATASHEET.	MATERIALSEE NOTESDR.FINISHSEE NOTESAPUNLESS OTHERWISE SPECIFIED:ANDIMENSIONS ARE IN MM [IN]PRIN ACCORDANCE WITH ASME Y14.5-2009PR

3. COPROCESSOR BOARD AND FLEX INCLUDED WITH "P" OPTION CORES.

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DIMENSIO IN ACC	THERWISE SPECIFIED: DNS ARE IN MM [IN] CORDANCE WITH ME Y14.5-2009	THIRD ANGLE PROJEC	TIC
GENERAL TOLERANCES 0.5 TO 6 ±0.1 [.004] > 6 TO 30 ±0.2 [.008] > 30 TO 120 ±0.2 [.008] >120 TO 400 ±0.3 [.012] ANGLES ±1°		THE IN IN TH PRC ANY R AS A PEF	HIS I PEF
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